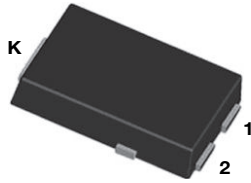
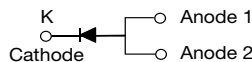


## Ultrafast Avalanche Surface Mount Rectifiers

### eSMP® Series



### SMPC (TO-277A)



### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	3.0 A
$V_{RRM}$	800 V, 1000 V
$I_{FSM}$	45 A
$t_{tr}$	75 ns
$E_{AS}$	20 mJ
$V_F$ at $I_F = 3.0$ A	1.45 V
$T_J$ max.	175 °C
Package	SMPC (TO-277A)
Circuit configuration	Single

### FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Glass passivated pellet chip junction
- Fast reverse recovery time
- Controlled avalanche characteristics
- Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### TYPICAL APPLICATIONS

For use in lighting, fast switching rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

### MECHANICAL DATA

#### Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3\_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,.....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

### MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	AU3PK	AU3PM	UNIT
Device marking code		AU3K	AU3M	
Maximum repetitive peak reverse voltage	$V_{RRM}$	800	1000	V
Maximum DC forward current (fig. 1)	$I_F^{(1)}$	3.0		A
	$I_F^{(2)}$	1.4		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	45		A
Non-repetitive avalanche energy at $T_J = 25$ °C	$E_{AS}$	$I_{AS} = 2.5$ A max.		mJ
		$I_{AS} = 1.0$ A typ.		
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +175		°C

### Notes

(1) Mounted on 20 mm x 20 mm pad areas, 1 oz. FR4 PCB

(2) Free air, mounted on recommended pad area

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	$I_F = 3.0\text{ A}$	$V_F^{(1)}$	$T_A = 25\text{ }^\circ\text{C}$	2.27	2.5	V
			$T_A = 125\text{ }^\circ\text{C}$	1.45	2.0	
Reverse current	Rated $V_R$	$I_R^{(2)}$	$T_A = 25\text{ }^\circ\text{C}$	0.40	10	$\mu\text{A}$
			$T_A = 125\text{ }^\circ\text{C}$	107	500	
Maximum reverse recovery time	$I_F = 0.5\text{ A}$ , $I_R = 1.0\text{ A}$ , $t_{rr} = 0.25\text{ A}$	$t_{rr}$	58	75	ns	
Typical junction capacitance per diode	Rated $V_R = 4.0\text{ V}$ , 1 MHz	$C_J$	42	-	pF	

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: Pulse width  $\leq 40\text{ ms}$ **THERMAL CHARACTERISTICS** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

PARAMETER	SYMBOL	AU3PK	AU3PM	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	85		$^\circ\text{C/W}$
	$R_{\theta JM}^{(2)}$	5		

**Notes**(1) Free air, mounted on recommended PCB 1 oz. pad are; thermal resistance  $R_{\theta JA}$  - junction to ambient(2) Units mounted on PCB with 20 mm x 20 mm copper pad areas;  $R_{\theta JM}$  - junction to mount**ORDERING INFORMATION** (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
AU3PM-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel
AU3PM-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel
AU3PMHM3_A/H <sup>(1)</sup>	0.10	H	1500	7" diameter plastic tape and reel
AU3PMHM3_A/I <sup>(1)</sup>	0.10	I	6500	13" diameter plastic tape and reel

**Note**

(1) AEC-Q101 qualified

**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

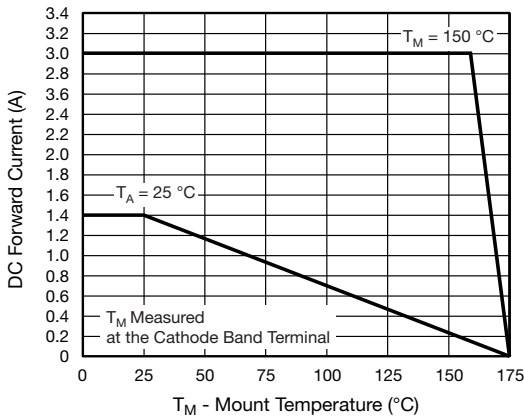


Fig. 1 - Maximum Forward Current Derating Curve

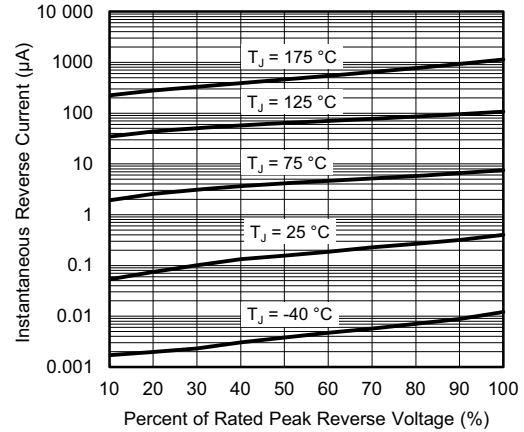


Fig. 4 - Typical Reverse Leakage Characteristics

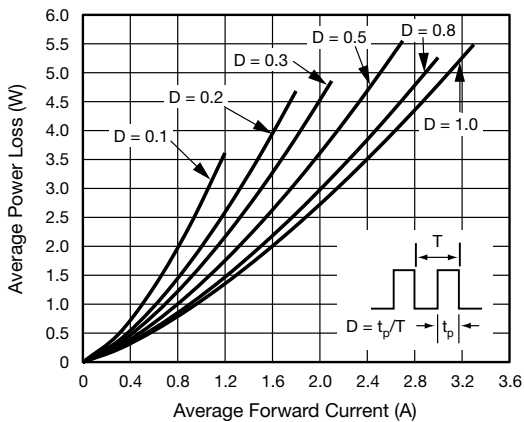


Fig. 2 - Average Power Loss Characteristics

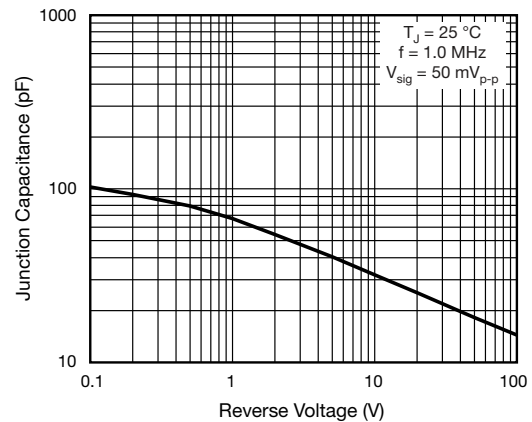


Fig. 5 - Typical Junction Capacitance

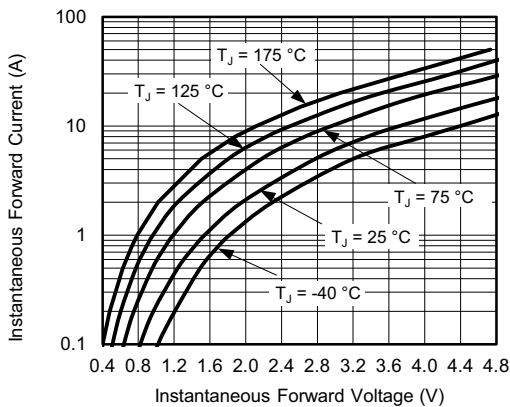


Fig. 3 - Typical Instantaneous Forward Characteristics

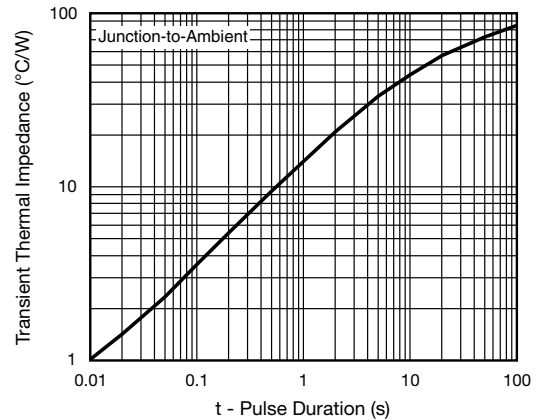
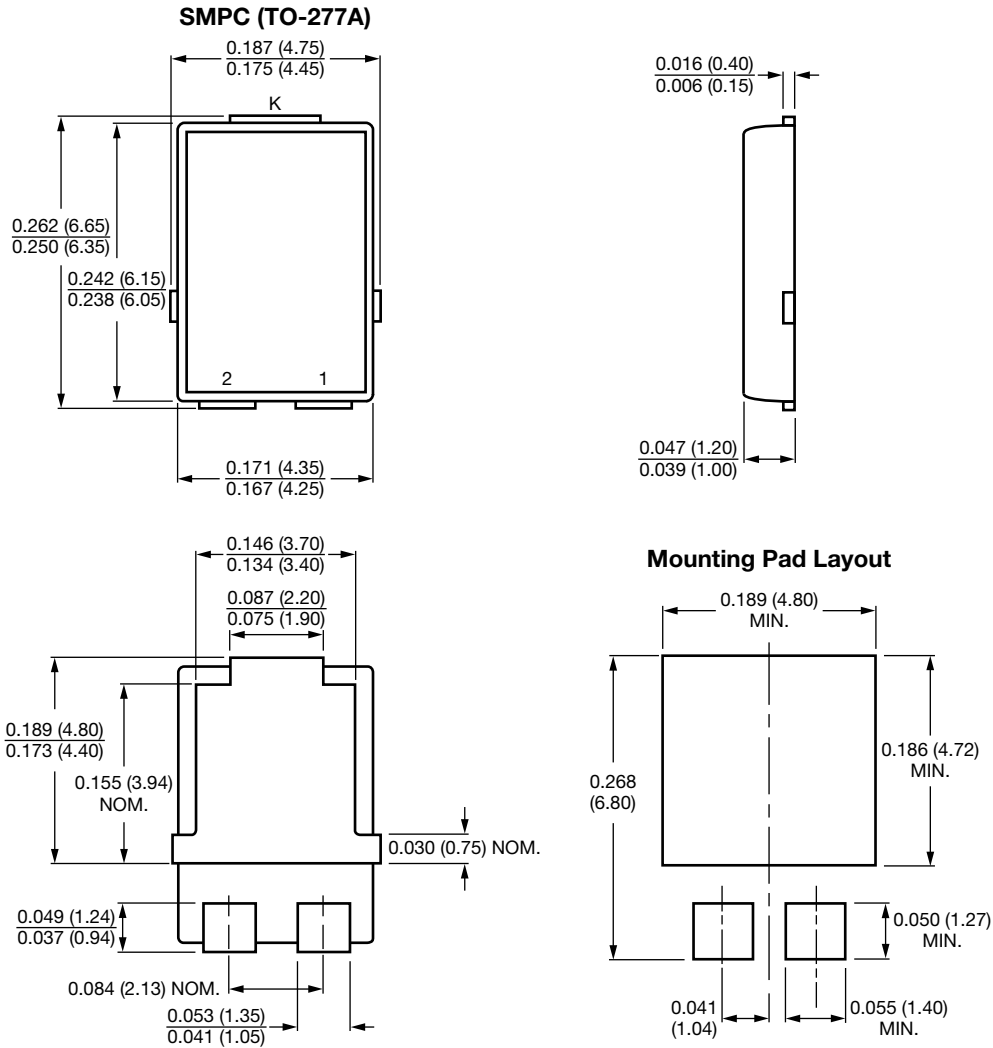


Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Conform to JEDEC® TO-277A



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